TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TD62593AFN,TD62594AFN,TD62597AFN,TD62598AFN

8CH SINGLE DRIVER: COMMON EMITTER

The TD62593, 4, 7, 8AFN are comprised of eight NPN Transistor Arrays.

Applications include relay, hammer, lamp and display (LED) drivers.

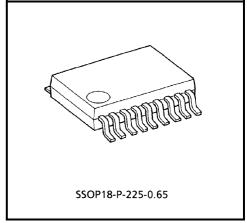
FEATURES

• Package Type: SSOP18pin (0.65 mm pitch)

• High Sustaining Voltage Output : 50 V (MIN)

• Low Saturation Voltage : $V_{CE (sat)} = 0.8 \text{ V}$ @ $I_{OUT} = 150 \text{ mA} \cdot I_{nputs}$ Compatible with Various type Logic. TD62593 AFN, TD62597 AFN: $R_{IN} = 2.7 \text{ k}\Omega$ TTL, 5 V CMOS TD62594 AFN, TD62598 AFN: $R_{IN} = 10.5 \text{ k}\Omega$ 6~15 V PMOS,

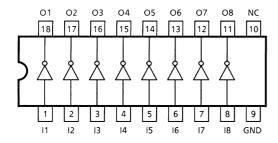
CMOS



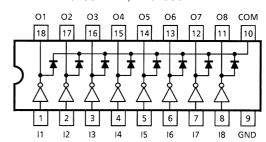
Weight: 0.09 g (Typ.)

PIN CONNECTION (TOP VIEW)

TD62593AFN, TD62594AFN

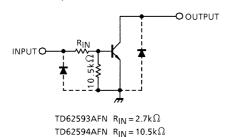


TD62597AFN, TD62598AFN

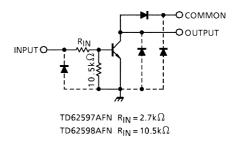


SCHEMATICS (EACH DRIVER)

TD62593AFN, TD62594AFN



TD62597AFN, TD62598AFN



Note: The input and output parasitic diodes cannot be used as clamp diodes.



MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT	
Collector-Emitter Voltage	V _{CEO}	50	V	
Collector-Base Voltage	V _{CBO}	50	V	
Clamp Diode Reverse Voltage	V _R (Note 1)	50	V	
Collector Current	IC	200	mA / ch	
Input Voltage	V _{IN}	-0.5~30	V	
Power Dissipation	P _D (Note 2)	0.96	W	
Operating Temperature	T _{opr}	-40~85	°C	
Storage Temperature	T _{stg}	-55~150	°C	

Note 1: Except TD62593AFN, TD62594AFN

Note 2: On Glass Epoxy PCB (50 × 50 ×1.6 mm Cu 40%)

RECOMMENDED OPERATING CONDITIONS (Ta = -40~85°C)

CHARACTERISTIC		SYMBOL	CONDITION	MIN	TYP.	MAX	UNIT
Collector-Emitter Voltage		V _{CEO}		0	_	50	V
Collector-Base Voltage		V _{CBO}			_	50	V
Collector Current		IC		0	_	150	mA / ch
Clamp Diode Reverse Voltage		V _R (Note 1)		7	_	50	V
Input Voltage		V _{IN}		0	_	25	V
Input Current	Input Current			0	_	10	mA
Input Voltage (Output On)	TD62593AFN TD62597AFN	VIN (ON)		2.4	_	25	· V
	TD62594AFN TD62598AFN			7.0	_	25	
Power Dissipation	Power Dissipation P _D (I			_	_	0.4	W

Note 1: Except TD62593AFN, TD62594AFN

Note 2: On Glass Epoxy PCB (50 × 50 × 1.6 mm Cu 40%)

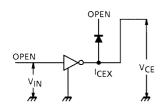
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARA	CTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
Output Leakage	Current	I _{CEX}	1	V _{CE} = 50 V, V _{IN} = 0	_	_	10	μΑ
Output Saturation Voltage		V _{CE (sat)}	2	I _C = 10 mA, I _{IN} = 0.4 mA	_	_	0.2	V
				I _C = 150 mA, I _{IN} = 3.0 mA	_	_	8.0	
DC Current Trans	sfer Ratio	h _{FE}	2	V _{CE} = 10 V, I _C = 10 mA	50	_	_	
Input Current	TD62593AFN TD62597AFN	1	3	V _{IN} = 2.4 V, I _C = 50 mA	_	_	0.9	mA
	TD62594AFN TD62598AFN	IIN (ON)		V _{IN} = 7.0 V, I _C = 50 mA	_	_	0.9	
Turn-On Delay		t _{ON}	4	V 50 V P. = 220 O	_	0.1	_	116
Turn-Off Delay		toff	4	V_{OUT} = 50 V, R_L = 330 Ω	_	3.0	_	μs

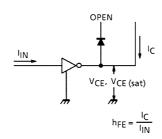
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TEST CIRCUIT

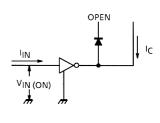
1. ICEX



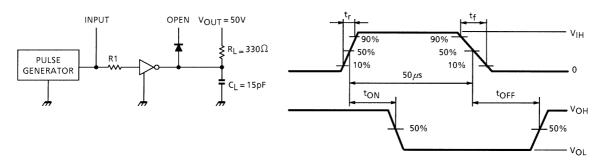
2. hfe, VCE (sat)



3. I_{IN} (ON)



4. ton, toff



Note 1: Pulse Width 50 µs, Duty Cycle 10%

Output Impedance 50 Ω , $t_r \le 5$ ns, $t_f \le 10$ ns

Note 2: See below

Input Condition

TYPE NUMBER	R _{IN}	V _{IH}		
TD62593AFN, TD62597AFN	0 Ω	3 V		
TD62594AFN, TD62598AFN	0 Ω	10 V		

Note 3: C_L includes probe and jig capacitance

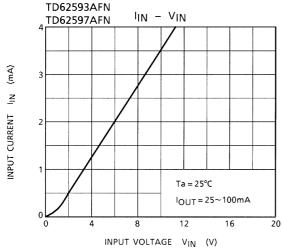
PRECAUTIONS for USING

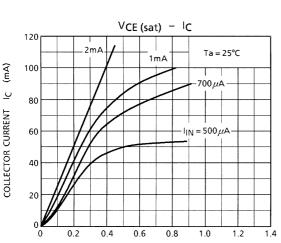
This IC does not integrate protection circuits such as overcurrent and overvoltage protectors.

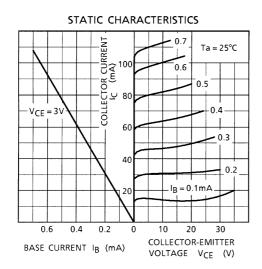
Thus, if excess current or voltage is applied to the IC, the IC may be damaged. Please design the IC so that excess current or voltage will not be applied to the IC.

Utmost care is necessary in the design of the output line, VCC and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

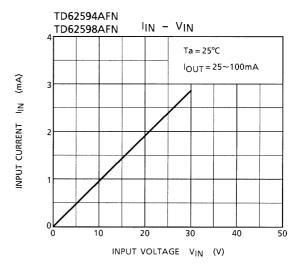
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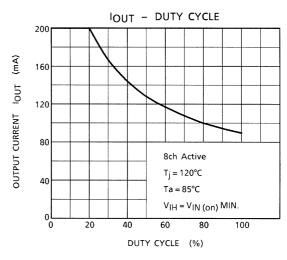


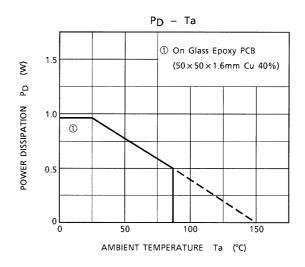




OUTPUT SATURATION VOLTAGE VCE (sat) (V)

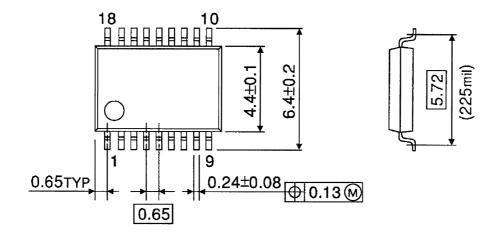


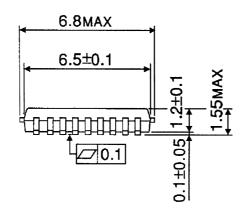


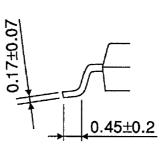


PACKAGE DIMENSIONS

SSOP18-P-225-0.65 Unit: mm







Weight: 0.09 g (Typ.)

RESTRICTIONS ON PRODUCT USE

000707EBA

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